



Click here for the 3D model.

Dimensions		
Chip Size	0805	
L	2.03mm +/-0.38mm (0.08 in +/-0.015 in)	
W	1.27mm +/-0.38mm (0.05 in +/-0.015 in)	
Т	1.4mm MAX (0.055 in MAX)	
В	0.51mm +/-0.25mm (0.02 in +/-0.01 in)	

General Information			
Series	GR900 SMD Space		
Style	SMD Chip		
RoHS	Yes		
Termination	Tin		
Failure Rate	N/A		
Testing and Reliability	GR900 CSAM A		
AEC-Q200	No		
Shelf Life	78 Weeks		
MSL	1		

Specifications			
Capacitance	330 pF		
Capacitance Tolerance	10%		
Voltage DC	200 VDC		
Temperature Range	-55/+125°C		
Temperature Coefficient	BX		

Packaging Specifications

Packaging

T&R, Plastic Tape

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